

1999 Fairchild Semiconductor Corporation

$I_C = 3 \text{ A}, I_B = 300 \text{ mA}$ 600 $V_{BE(sat)}$ Base-Emitter Saturation Voltage $I_C = 1 \text{ A}, I_B = 100 \text{ mA}$ 1.25 $V_{BE(on)}$ Base-Emitter On Voltage $I_C = 1 \text{ A}, V_{CE} = 2 \text{ V}$ 1SMALL SIGNAL CHARACTERISTICS	ymbol	Parameter	Test Conditions	Min	Max	Units
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	F CHAF	RACTERISTICS				
V_{CB} Emitter-Base Breakdown VoltageIE I_{C} = 100 µA5 I_{CBO} Collector Cutoff Current V_{CB} = 30 V100 I_{CBO} Emitter Cutoff Current V_{CB} = 30 V, T_{A} =100°C10 I_{EBO} Emitter Cutoff Current V_{EB} = 4V100ON CHARACTERISTICS* h_{FE} DC Current Gain I_{C} = 50 mA, V_{CE} = 2 V70 I_{C} = 1 A, V_{CE} = 2 V100300 I_{C} = 6 A, V_{CE} = 2 V7515 $V_{CE(sat)}$ Collector-Emitter Saturation Voltage I_{C} = 1 A, I_{B} = 100 mA300 $V_{BE(sat)}$ Base-Emitter Saturation Voltage I_{C} = 1 A, I_{B} = 100 mA1.25 $V_{BE(on)}$ Base-Emitter On Voltage I_{C} = 1 A, V_{CE} = 2 V1SMALL SIGNAL CHARACTERISTICS	CEO	Collector-Emitter Breakdown Voltage	I _C = 10 mA	25		V
SVEBOCollector Cutoff CurrentVCB = 30 V VCB = 30 V, T_A=100°C100 10IEEOEmitter Cutoff CurrentVEB = 4V100ON CHARACTERISTICS*IC = 50 mA, VCE = 2 V IC = 1 A, VCE = 2 V70 100DC Current GainIC = 50 mA, VCE = 2 V IC = 1 A, VCE = 2 V70 100VCE(sat)Collector-Emitter Saturation VoltageIC = 1 A, IB = 100 mA IC = 1 A, IB = 300 mA300 600VBE(sat)Base-Emitter Saturation VoltageIC = 1 A, IB = 100 mA IC = 1 A, IB = 100 mA300 100VBE(sat)Base-Emitter On VoltageIC = 1 A, IB = 100 mA1.25 100VBE(on)Base-Emitter On VoltageIC = 1 A, VCE = 2 V100 100SMALL SIGNAL CHARACTERISTICSIC = 1 A, VCE = 2 V100 100	СВО	Collector-Base Breakdown Voltage	I _C = 100 μA	35	-	V
CBOVCB = 30 V VCB = 30 V, T_A=100°C10EBOEmitter Cutoff CurrentVEB = 4V100ON CHARACTERISTICS*IC = 50 mA, VCE = 2 V IC = 1 A, VCE = 2 V70 100300FEDC Current GainIC = 50 mA, VCE = 2 V IC = 1 A, VCE = 2 V75 100300VCE(sat)Collector-Emitter Saturation VoltageIC = 1 A, IB = 100 mA IC = 3 A, IB = 300 mA300 600VBE(sat)Base-Emitter Saturation VoltageIC = 1 A, IB = 100 mA IC = 1 A, IB = 100 mA1.25 100VBE(on)Base-Emitter On VoltageIC = 1 A, VCE = 2 V1SMALL SIGNAL CHARACTERISTICSIC = 1 A, VCE = 2 V1	EBO	Emitter-Base Breakdown Voltage	I _E = 100 μA	5		V
Image: transformed base of the transformed base of the transformed base of the transformed base of the transformed base of transf	0	Collector Cutoff Current	V _{CB} = 30 V		100	nA
EBD $V = B - 4V$ ON CHARACTERISTICS*DFEDC Current GainIc = 50 mA, VcE = 2 V70Ic = 1 A, VcE = 2 V100300Ic = 2 A, VcE = 2 V75IcIc = 6 A, VcE = 2 V1515VcE(sat)Collector-Emitter Saturation VoltageIc = 1 A, IB = 100 mA300Ic = 3 A, IB = 300 mAIc = 1 A, IB = 100 mA600VBE(sat)Base-Emitter Saturation VoltageIc = 1 A, IB = 100 mA1.25VBE(on)Base-Emitter On VoltageIc = 1 A, VcE = 2 V1SMALL SIGNAL CHARACTERISTICS			$V_{CB} = 30 \text{ V}, \text{ T}_{A} = 100^{\circ}\text{C}$		10	uA
DFEDC Current GainIC = 50 mA, VCE = 2 V70IC = 1 A, VCE = 2 V100300IC = 2 A, VCE = 2 V75IC = 6 A, VCE = 2 V15VCE(sat)Collector-Emitter Saturation VoltageIC = 1 A, IB = 100 mA300IC = 3 A, IB = 300 mAIC = 1 A, IB = 100 mA600VBE(sat)Base-Emitter Saturation VoltageIC = 1 A, IB = 100 mA1.25VBE(sat)Base-Emitter On VoltageIC = 1 A, VCE = 2 V1SMALL SIGNAL CHARACTERISTICSIC = 1 A, VCE = 2 V1	0	Emitter Cutoff Current	$V_{EB} = 4V$		100	nA
InFEInC = 50 HIA, VCE = 2 V100300 $I_C = 1 A, V_{CE} = 2 V$ $I_{C} = 1 A, V_{CE} = 2 V$ 100300 $I_C = 2 A, V_{CE} = 2 V$ $I_C = 6 A, V_{CE} = 2 V$ 1515 $V_{CE(sat)}$ Collector-Emitter Saturation Voltage $I_C = 1 A, I_B = 100 \text{ mA}$ 300 $I_C = 3 A, I_B = 300 \text{ mA}$ $I_C = 3 A, I_B = 300 \text{ mA}$ 600 $V_{BE(sat)}$ Base-Emitter Saturation Voltage $I_C = 1 A, I_B = 100 \text{ mA}$ 1.25 $V_{BE(on)}$ Base-Emitter On Voltage $I_C = 1 A, V_{CE} = 2 V$ 1SMALL SIGNAL CHARACTERISTICS	I CHAR					
ICICICICICIC2 A, VCE2 V75IC2 A, VCE2 V15VCE(sat)Collector-Emitter Saturation VoltageIC1 A, IB100 mA300IC3 A, IB300 mA600600VBE(sat)Base-Emitter Saturation VoltageIC1 A, IB100 mA1.25VBE(on)Base-Emitter On VoltageIC1 A, VCE2 V1SMALL SIGNAL CHARACTERISTICS	Ē	DC Current Gain		-		-
IC = 6 A, VCE = 2 V15 $V_{CE(sat)}$ Collector-Emitter Saturation VoltageIC = 1 A, IB = 100 mA300IC = 3 A, IB = 300 mAIC = 3 A, IB = 300 mA600 $V_{BE(sat)}$ Base-Emitter Saturation VoltageIC = 1 A, IB = 100 mA1.25 $V_{BE(on)}$ Base-Emitter On VoltageIC = 1 A, VCE = 2 V1SMALL SIGNAL CHARACTERISTICS					300	
$V_{CE(sat)}$ Collector-Emitter Saturation Voltage $I_C = 1 \text{ A}, I_B = 100 \text{ mA}$ 300 $I_C = 3 \text{ A}, I_B = 300 \text{ mA}$ $I_C = 3 \text{ A}, I_B = 300 \text{ mA}$ 600 $V_{BE(sat)}$ Base-Emitter Saturation Voltage $I_C = 1 \text{ A}, I_B = 100 \text{ mA}$ 1.25 $V_{BE(on)}$ Base-Emitter On Voltage $I_C = 1 \text{ A}, V_{CE} = 2 \text{ V}$ 1SMALL SIGNAL CHARACTERISTICS				-		
$I_C = 3 A$, $I_B = 300 mA$ 600 $V_{BE(sat)}$ Base-Emitter Saturation Voltage $I_C = 1 A$, $I_B = 100 mA$ 1.25 $V_{BE(on)}$ Base-Emitter On Voltage $I_C = 1 A$, $V_{CE} = 2 V$ 1SMALL SIGNAL CHARACTERISTICS	V _{CE(sat)}	Collector-Emitter Saturation Voltage		10	300	mV
VBE(sal) IC = 1 A, VCE = 2 V SMALL SIGNAL CHARACTERISTICS					600	
VBE(on) Base-Emitter On Voltage IC = 1 A, VCE = 2 V 1 SMALL SIGNAL CHARACTERISTICS 0.100000000000000000000000000000000000	E(sat)	Base-Emitter Saturation Voltage	I _C = 1 A, I _B = 100 mA		1.25	V
SMALL SIGNAL CHARACTERISTICS		Base-Emitter On Voltage			1	V
Output Capacitance $V_{CR} = 10 V_{LR} = 0 f = 1 MHz$ 100		GNAL CHARACTERISTICS			1	1
	00	Output Capacitance	V _{CB} = 10 V, I _E = 0, f = 1MHz		100	pF
Transition Frequency $I_{C} = 100 \text{ mA}, V_{CE} = 5 \text{ V}, f=100 \text{ MHz}$ 100		Transition Frequency	I _C = 100 mA,V _{CE} = 5 V, f=100MHz	100		-
Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%	se Test: P	Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%			4	4

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